SiHG30N60E

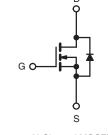
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E Series Power MOSFET

PRODUCT SUMMA	RY			
V _{DS} (V) at T _J max.	650)		
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.125		
Q _g max. (nC)	130			
Q _{gs} (nC)	15			
Q _{gd} (nC)	39			
Configuration	Sing	le		





N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (Ciss)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_g)
- Avalanche Energy Rated (UIS)
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
 - LED Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers
- Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG30N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600		
Gate-Source Voltage			N/	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			V _{GS} 30		1	
Continuous Durin Current /T 150 °C)	V _{GS} at 10 V	T _C = 25 °C		29		
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	18	А	
Pulsed Drain Current ^a			I _{DM}	65		
Linear Derating Factor				2	W/°C	
Avalanche Energy (repetitive)			E _{AR}	0.25		
Single Pulse Avalanche Energy ^b			E _{AS}	690	— mJ	
Maximum Power Dissipation			PD	250	W	
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 1	25 °C	dV/dt	37	V/ns	
Reverse Diode dV/dt ^d	•		av/dt	18	v/ns	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^c	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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COMPLIANT

HALOGEN



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PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT				
Maximum Junction-to-Ambient	R _{thJA}	-		62			0 0 00				
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.5 °C/W									
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)									
PARAMETER	SYMBOL			MAX.	UNIT						
Static								1			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 μA	600	-	-	V			
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _I	₀ = 250 μA	-	0.64	-	V/°C			
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2.0	-	4.0	V			
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20$	V	-	-	± 100	nA			
		V _{DS} =	= 600 V, V _G	_s = 0 V	-	-	1				
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 600 V, V_{GS} = 0 V, T_J = 150 °C		100	μA						
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	Ic	₀ = 15 A	-	0.104	0.125	Ω			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 8 V, I_D = 3 A$ - 5.4 - 5		S							
Dynamic			-				1	1			
Input Capacitance	C _{iss}		V _{GS} = 0 V,		-	2600	-				
Output Capacitance	C _{oss}		V _{DS} = 100 \	Ι,	-	138	-	pF			
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz - 3 -									
Total Gate Charge	Qg										
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 15 /	A, V _{DS} = 480 V	-	15	-	nC			
Gate-Drain Charge	Q _{gd}				-	39	-				
Turn-On Delay Time	t _{d(on)}				-	19	40				
Rise Time	t _r	Vee -	- 380 V In -	- 15 Δ	-	32	65	-			
Turn-Off Delay Time	t _{d(off)}	$ \begin{array}{c c} t_r & & & - & 32 & 65 \\ \hline v_{Gff} & & V_{GS} = 10 \ V, \ R_g = 4.7 \ \Omega & & - & 63 & 95 \\ \end{array} $	ns								
Fall Time	t _f										
Gate Input Resistance	Rg	- 36 75 f = 1 MHz, open drain - 0.63 -		Ω							
Drain-Source Body Diode Characteristic	s										
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol		-	-	29				
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	65	A				
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 15 A	, V _{GS} = 0 V	-	-	1.3	V			
Body Diode Reverse Recovery Time	t _{rr}	1			-	402	605	ns			
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 15 \text{ A},$ 7 15		μC							
Reverse Recovery Current	I _{RRM}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	A								

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

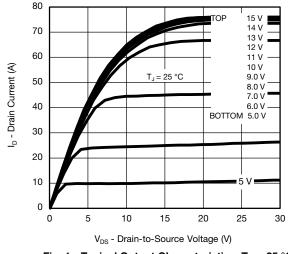
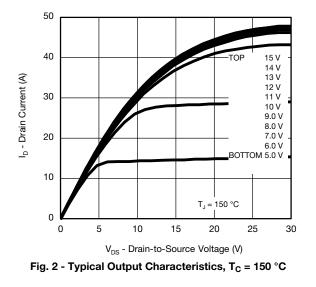


Fig. 1 - Typical Output Characteristics, T_C = 25 °C



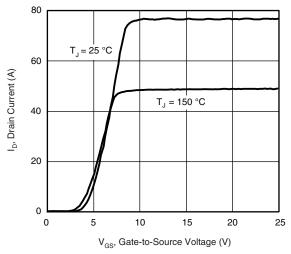
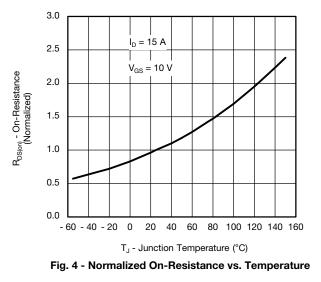


Fig. 3 - Typical Transfer Characteristics

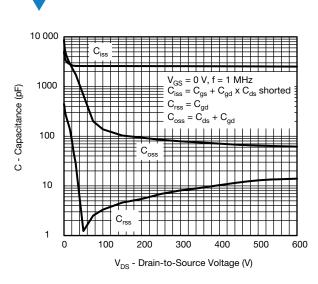


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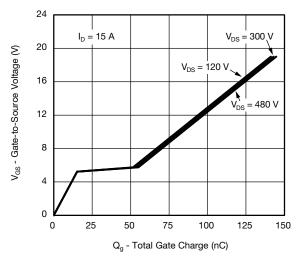
SiHG30N60E



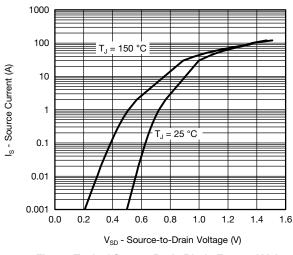


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Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage









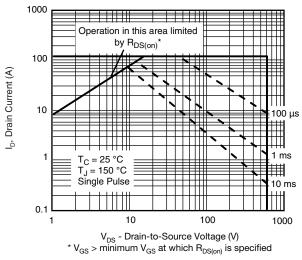


Fig. 8 - Maximum Safe Operating Area

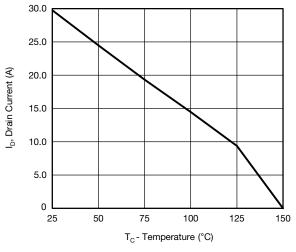
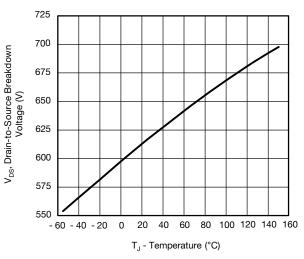


Fig. 9 - Maximum Drain Current vs. Case Temperature



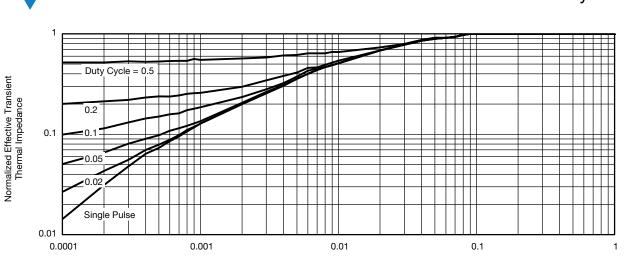


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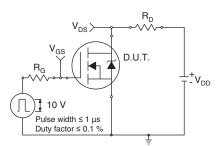
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Square Wave Pulse Duration (s) Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



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Fig. 12 - Switching Time Test Circuit

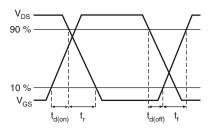


Fig. 13 - Switching Time Waveforms

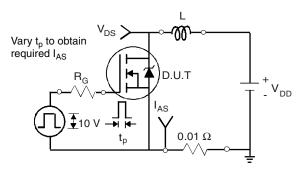


Fig. 14 - Unclamped Inductive Test Circuit

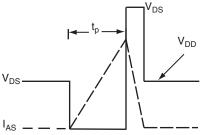


Fig. 15 - Unclamped Inductive Waveforms

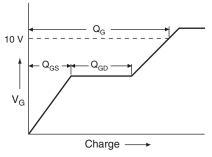


Fig. 16 - Basic Gate Charge Waveform

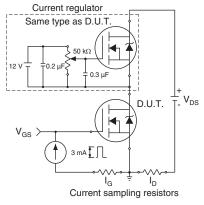


Fig. 17 - Gate Charge Test Circuit

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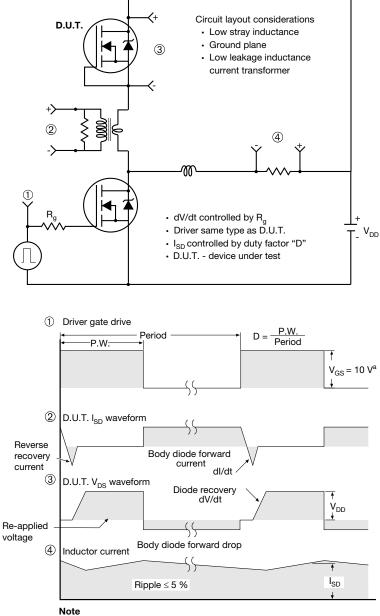
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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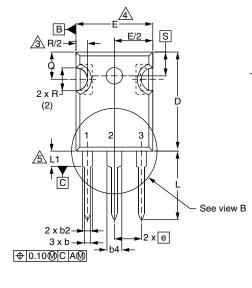
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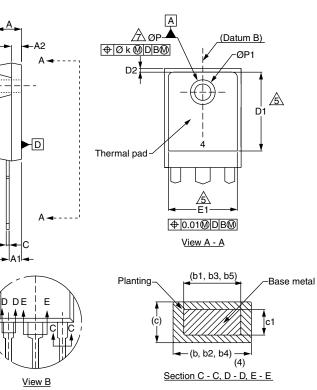


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TO-247AC (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES			MILLIMETERS		INC			
	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.			
А	4.65	5.31	0.183	0.209	D2	0.51	1.30	0.020			
A1	2.21	2.59	0.087	0.102	E	15.29	15.87	0.602			
A2	1.50	2.49	0.059	0.098	E1	13.72	-	0.540			
b	0.99	1.40	0.039	0.055	е	5.46 BSC		0.215 B			
b1	0.99	1.35	0.039	0.053	Øk	0.254		0.254		0.0)
b2	1.65	2.39	0.065	0.094	L	14.20	16.10	0.559			
b3	1.65	2.37	0.065	0.093	L1	3.71	4.29	0.146			
b4	2.59	3.43	0.102	0.135	Ν	7.62	BSC	0.300 BSC	I		
b5	2.59	3.38	0.102	0.133	ØР	3.56	3.66	0.140			
С	0.38	0.86	0.015	0.034	Ø P1	-	7.39	-			
c1	0.38	0.76	0.015	0.030	Q	5.31	5.69	0.209	I		
D	19.71	20.70	0.776	0.815	R	4.52	5.49	0.178			
D1	13.08	-	0.515	0.515 -		5.51 BSC		0.217	7		

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.



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